HTIRC-02-004

February 9, 2004

To: Commissioner for Patents P.O.Box 1450

Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No. 19,572 28 Davis Avenue Poughkeepsie, N.Y. 12603

Subject:

| Serial No. 10/718,373 11/20/03

Min Li et al.

METHOD OF INCREASING CPP GMR IN A SPIN VALVE STRUCTURE

INFORMATION DISCLOSURE STATEMENT

Enclosed is Form PTO-1449, Information Disclosure Citation In An Application.

The following Patents and/or Publications are submitted to comply with the duty of disclosure under CFR 1.97-1.99 and 37 CFR 1.56.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on February , 2004.

Stephen B. Ackerman, Reg.# 37761

- U.S. Patent 5,627,704 to Lederman et al., "Thin Film Giant Magnetoresistive CPP Transducer with Flux Guide Yoke Structure," discloses a CPP GMR stack structure formed within a gap located in one of two pole layers of a magnetic yoke structure which also has a transducing gap formed in an ABS plane.
- U.S. Patent 5,731,937 to Yuan, "Giant Magnetoresistive Transducer with Increased Output Signal," discloses a CPP sensor configuration having sensing element dimensions in a particular ratio to current lead dimensions so that the efficiency of the element is thereby increased.
- U.S. Patent 6,219,205 to Yuan et al., "High Density Giant Magnetoresistive Transducer with Recessed Sensor," discloses magnetic transducers employing giant magnetoresistance (GMR) and shielded GMR transducer.
- U.S. Patent 5,668,688 to Dykes et al., "Current Perpendicular-to-the-plane Spin Valve Type Magnetoresistive Transducer," discloses a spin valve CPP configuration in which the active layers form a stack of uniform width disposed between upper and lower shield and conductor layers.

- U.S. Patent 6,347,022 to Saito, "Spin-valve Type Magnetoresistive Thin Film Element and Spin-valve Type Magnetoresistive Thin Film Head Using the Same," discloses a dual spin-valve configuration in which a magnetically free layer is sandwiched between magnetically pinned layers and which provides an advantageously vertically asymmetric structure and good resistance variations.
- U.S. Patent 5,880,912 to Rottmayer, "Magnetic Head with Biased GMR Element and Sense Current Compensation," provides a GMR sensing element having a canted bias field which cancels the adverse affect of the field produced by the applied sensing current and thereby increases the magnitude of the sensing current that can be used.
- U.S. Patent 6,317,297 to Tong et al., "Current Pinned Dual Spin Valve with Synthetic Pinned Layers," provides a spin valve configuration with improved linearity and a wider temperature range for thermal stability.

Co-pending U.S. Patent Application HTIRC-02-003, Serial No. 10/392,118, filed 03/19/03, assigned to the same assignee, "GMR Improvement in CPP Valve Head by Inserting a Current Channeling Layer (CCL)," discusses the fabrication of giant magnetoresistive (GMR) magnetic field sensors of a "current-perpendicular-to-the-plane" (CPP) configuration.

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Co-pending U.S. Patent Application HTIRC-02-006, Serial No. 10/718,372, filed 11/20/03, assigned to the same assignee, "Self-Alignment Scheme for Enhancement of CPP-GMR," discusses the fabrication of giant magnetoresistive (GMR) magnetic field sensors of a "Current-perpendicular-to-the-plane" (CPP) configuration.

- U.S. Patent 6,198,609 to Barr et al., "CPP Magnetoresistive Device with Reduced Edge Effect and Method for Making Same," discusses methods and structures for current-perpendicular-to-plane (CPP) operation of submicron GMR heads.
- U.S. Patent 6,205,008 to Gijs et al., "Magnetic-Resistance Device, and Magnetic Head Employing Such a Device," discusses a magneto-resistance device comprising two layers of ferromagnetic material mutually separated by at least one interposed layer of non-ferromagnetic material.
- U.S. Patent 6,233,125 to Knapp et al., "CPP Magnetoresistive Device and Method for Making Same," discusses methods and structures for current-perpendicular-to-plane operation of submicron MR heads.

Sincerely,

Stephen B. Ackerman,

Req. No. 37761

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.